

Flexible PWMs Enable Multi-Axis Drives, Multi-Level Inverters

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Industrial Drives and Automation C2000 Microcontrollers

ABSTRACT

High-performance control peripherals are an integral component for all digital control systems. The hallmark of the Delfino F2837xD devices are the control peripherals including the flexible, powerful, industry-proven PWM timers. Each of the PWM modules is enhanced to support high resolution capabilities on both A and B channels. These high-resolution channels extend 150ps PWM step resolution to enable high-frequency PWM modulation techniques and advanced control topologies. The 12 pulse width modulator pairs enable single-chip multi-axis controllers and single-chip multi-level inverters controllers.

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1 Enhanced Pulse Width Modulator (ePWM) Module

Power switching devices can be difficult to control when operating in the proportional region, but are easy to control in the saturation and cutoff regions. Since PWM is a digital signal by nature and easy for an MCU to generate, it is ideal for use with power switching devices. Essentially, PWM performs a DAC function, where the duty cycle is equivalent to the DAC analog amplitude value. The F2837xD ePWM modules are highly programmable, extremely flexible, and easy to use, while being capable of generating complex pulse width waveforms with minimal CPU overhead or intervention. Each ePWM module is identical with two PWM outputs, EPWMxA and EPWMxB, and multiple modules can be synchronized to operate together as required by the system application design. The ePWM module consists of eight submodules: time-base, counter-compare, action-qualifier, dead-band generator, PWM chopper, trip-zone, digital-compare, and event-trigger.

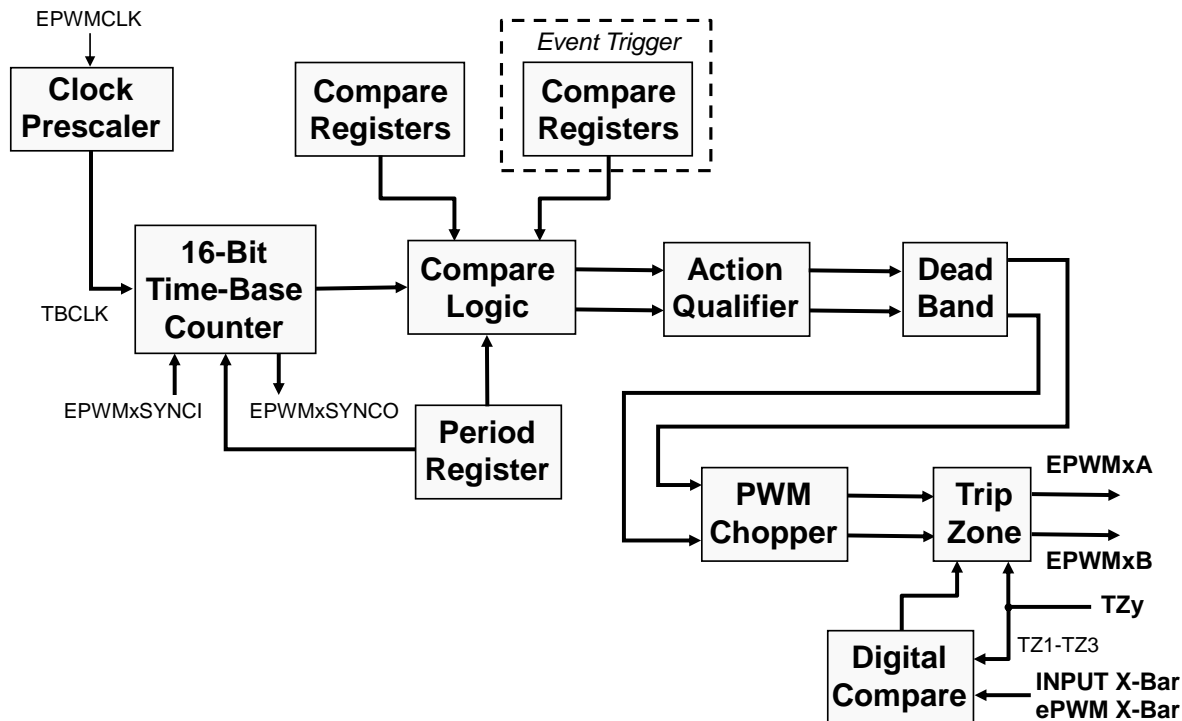


Figure 1. Enhanced Pulse Width Modulator (ePWM) Module Block Diagram

The time-base submodule consists of a dedicated 16-bit counter, along with built-in synchronization logic to allow multiple ePWM modules to work together as a single system. A clock pre-scaler divides the EPWM clock to the counter and a period register is used to control the frequency and period of the generated waveform. The period register has a shadow register, which acts like a buffer to allow the register updates to be synchronized with the counter, thus avoiding corruption or spurious operation from the register being modified asynchronously by the software. The time-base counter operates in three modes: up-count, down-count, and up-down-count. In up-count mode the time-base counter starts counting from zero and increments until it reaches the period register value, then the time-base counter resets to zero and the count sequence starts again. Likewise, in down-count mode the time-base counter starts counting from the period register value and decrements until it reaches zero, then the time-base counter is loaded with the period value and the count sequence starts again. In up-down-count mode the time-base counter starts counting from zero and increments until it reaches the period register value, then the time-base counter decrements until it reaches zero and the count sequence repeats. The up-count and down-count modes are used to generate asymmetrical waveforms, and the up-down-count mode is used to generate symmetrical waveforms.

The counter-compare submodule continuously compares the time-base count value to four Counter Compare Registers (CMPA, CMPB, CMPC, and CMPD) and generates four independent compare events (that is, time-base counter equals a compare register value) which are fed to the action-qualifier and event-trigger submodules. The counter compare registers are shadowed to prevent corruption or glitches during the active PWM cycle. Typically CMPA and CMPB are used to control the duty cycle of the generated PWM waveform, and all four compare registers can be used to start an ADC conversion or generate an ePWM interrupt. For the up-count and down-count modes, a counter match occurs only once per cycle, however for the up-down-count mode a counter match occurs twice per cycle since there is a match on the up count and down count.

The action-qualifier submodule is the key element in the ePWM module which is responsible for constructing and generating the switched PWM waveforms. It utilizes match events from the time-base and counter-compare submodules for performing actions on the EPWMxA and EPWMxB output pins. These actions are setting the pin high, clearing the pin low, toggling the pin, or do nothing to the pin, based independently on count-up and count-down time-base match event. The match events are when the time-base counter equals the period register value, the time-base counter is zero, the time-base counter equals CMPA, the time-base counter equals CMPB, or a Trigger event (T1 and T2) based on a comparator, trip, or sync signal. Note that zero and period actions are fixed in time, whereas CMPA and CMPB actions are moveable in time by programming their respective registers. Actions are configured independently for each output using shadowed registers, and any or all events can be configured to generate actions on either output.

The dead-band submodule provides a classical approach for delaying the switching action of a power device. Since power switching devices turn on faster than they turn off, a delay is needed to prevent having a momentary short circuit path from the supply rail to ground. This submodule supports independently programmable rising-edge and falling-edge delays with various options for generating the appropriate signal outputs on EPWMxA and EPWMxB.

The PWM chopper submodule is used with pulse transformer-based gate drives to control the power switching devices. This submodule modulates a high-frequency carrier signal with the PWM waveform that is generated by the action-qualifier and dead-band submodules. Programmable options are available to support the magnetic properties and characteristics of the transformer and associated circuitry.

The trip-zone submodule utilizes a fast clock independent logic mechanism to quickly handle fault conditions by forcing the EPWMxA and EPWMxB outputs to a safe state, such as high, low, or high-impedance, thus avoiding any interrupt latency that may not protect the hardware when responding to over current conditions or short circuits through ISR software. It supports one-shot trips for major short circuits or over current conditions, and cycle-by-cycle trips for current limiting operation. The trip-zone signals can be generated externally from any GPIO pin which is mapped through the Input X-Bar (TZ1 – TZ3), internally from an inverted eQEP error signal (TZ4), system clock failure (TZ5), or from an emulation stop output from the CPU (TZ6). Additionally, numerous trip-zone source signals can be generated from the digital-compare subsystem.

The digital-compare subsystem compares signals external to the ePWM module, such as a signal from the CMPSS analog comparators, to directly generate PWM events or actions which are then used by the trip-zone, time-base, and event-trigger submodules. These 'compare' events can trip the ePWM module, generate a trip interrupt, sync the ePWM module, or generate an ADC start of conversion. A compare event is generated when one or more of its selected inputs are either high or low. The signals can originate from any external GPIO pin which is mapped through the Input X-Bar and from various internal peripherals which are mapped through the ePWM X-Bar. Additionally, an optional 'blanking' function can be used to temporarily disable the compare action in alignment with PWM switching to eliminate noise effects.

The event-trigger submodule manages the events generated by the time-base, counter-compare, and digital-compare submodules for generating an interrupt to the CPU and/or a start of conversion pulse to the ADC when a selected event occurs. These event triggers can occur when the time-base counter equals zero, period, zero or period, the up or down count match of a compare register (that is, CMPA, CMPB, CMPC, or CMPD). Recall that digital-compare subsystem can also generate an ADC start of conversion based on one or more compare events. The event-trigger submodule incorporates pre-scaling logic to issue an interrupt request or ADC start of conversion at every event or up to every fifteenth event.

The ePWM module is capable of significantly increase its time resolution capabilities over the standard conventionally derived digital PWM. This is accomplished by adding 8-bit extensions to the High-Resolution Compare Register (CMPxHR), Time Base Period High Resolution Register (TBPRDHR), and High-Resolution Phase Register (TBPHSHR), providing a finer time granularity for edge positioning control. This is known as high-resolution PWM (HRPWM) and it is based on micro edge positioner (MEP) technology.

The MEP logic is capable of positioning an edge very finely by sub-dividing one coarse system clock of the conventional PWM generator with time step accuracy on the order of 150 ps. A self-checking software diagnostics mode is used to determine if the MEP logic is running optimally, under all operating conditions such as for variations caused by temperature, voltage, and process. HRPWM is typically used when the PWM resolution falls below approximately 9 or 10 bits which occurs at frequencies greater than approximately 200 kHz with an EPWMCLK of 100 MHz.

2 For More Information

- To learn more about DesignDRIVE software, tools and kits for industrial drives and servo control development, visit www.ti.com/tool/DesignDRIVE
- To learn even more on the sensing circuits included on the Delfino F2837x microcontrollers, see the device-specific product group and data sheet at: www.ti.com/delfino, the *TMS320F2837xD Dual-Core Delfino Microcontrollers Technical Reference Manual* ([SPRUHM8](#)) or the *TMS320F2837xS Delfino Microcontrollers Technical Reference Manual* ([SPRUHX5](#)).
- To view online training on how to use DesignDRIVE solutions, see [DesignDRIVE training portal](#).
- For an introduction and general overview to the TMS320F2837xD microcontroller, see *The TMS320F2837xD Architecture: Achieving a New Level of High Performance Technical Brief* ([SPRT720](#))

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